

101256C

RD60-14-16X 60 MHz Dispersive Delay Line 14 MHz Bandwidth

Specifications

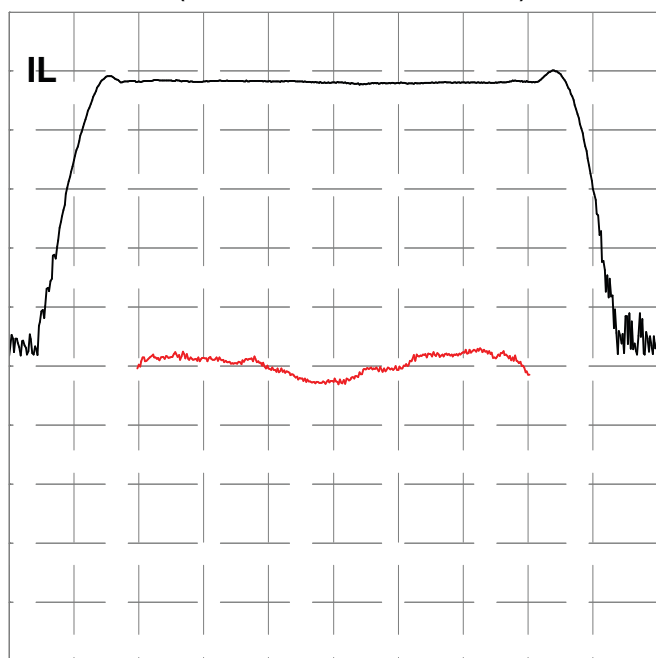
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	F_0		60		MHz
Bandwidth	B		14		MHz
Dispersion	T		16		μsec
Delay	T_0	11.4	11.432	11.5	μsec
Insertion Loss	IL		33.7	37	dB
Slope	S_0	-1.18	-1.17	-1.16	$\mu\text{s}/\text{MHz}$
Pulse Width at -3 dB			0.0581	0.0585	μsec
Sidelobes for $ t - T_0 < T$			-12.7	-11.5	dB
Time Spurious for $ t - T_0 > T$			-63	-58	dB
Substrate Material		128YX-LN			

Notes

- Center Frequency (F_0) and Bandwidth (B) are defined, not measured. Dispersion (T) is defined as $|B * S_0|$.
- Insertion Loss is the minimum loss for $|f - F_0| < .5B$
- Delay and Slope determined by best fit quadratic pulse in $|f - F_0| < .5B$.
- Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts $dF_0 = -x * F_0$, $dT_0 = x * (T_0 + S_0 * F_0)$, $dS_0 = x * 2 * S_0$, where $x = 75E-6 * (\text{temperature} - 22 \text{ °C})$

Typical Performance

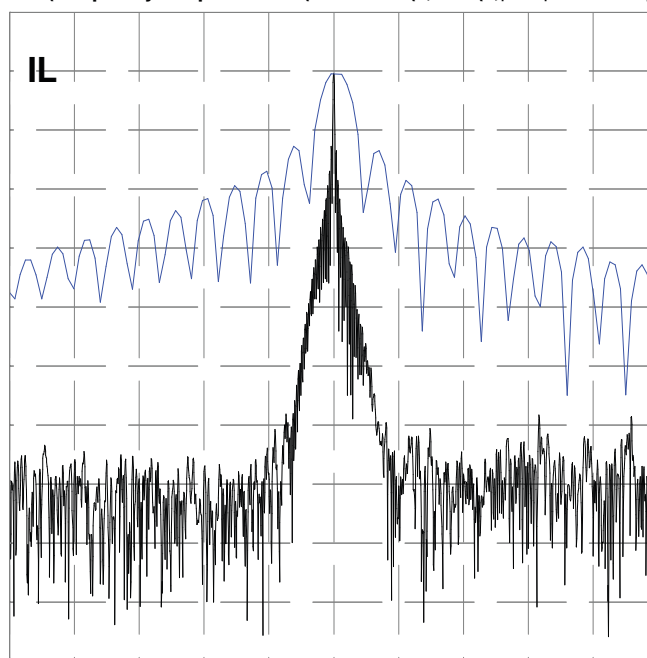
Frequency Response
(Best Fit Quadratic Phase Removed)



10 dB/div, 10 deg/div, 2.000 MHz/div

Compressed Pulse Response

FFT(Frequency Response * Cos(0.5 * Pi * MIN(1, MAX(0, |f - F0| * 4.7 / 14 - 2.3)))^2)

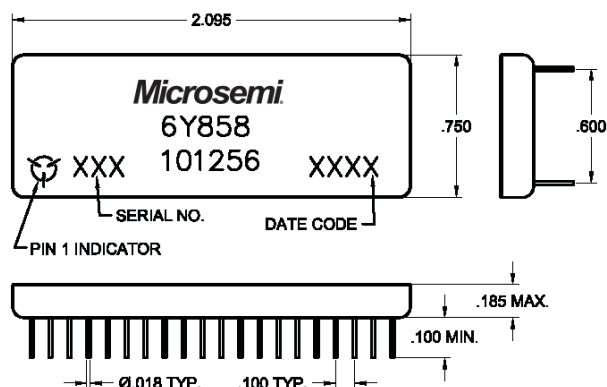


10 dB/div, 2.500 $\mu\text{s}/\text{div}$, 0.148 $\mu\text{s}/\text{div}$

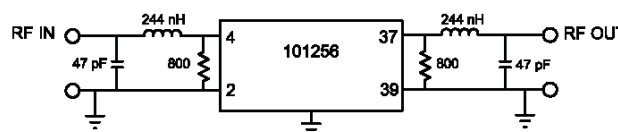
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Package Outline



Matching



Microsemi Corporate Headquarters
 One Enterprise, Aliso Viejo, CA 92656 USA
 Within the USA: +1 (800) 713-4113
 Outside the USA: +1 (949) 380-6100
 Fax: +1 (949) 215-4996
 Email: sales.support@microsemi.com
 www.microsemi.com

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